503434579 08/12/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Teng-Chun Tsai	08/03/2011
Chun-Yuan Wu	08/03/2011
Chih-Chien Liu	08/03/2011
Chin-Cheng Chien	08/03/2011
Chin-Fu Lin	08/03/2011

RECEIVING PARTY DATA

Name:	Vame: UNITED MICROELECTRONICS CORP.	
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City:	Hsin-Chu City	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14825165

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NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	08/12/2015

Total Attachments: 3 source=2323193#page1.tif source=2323193#page2.tif source=2323193#page3.tif

PATENT 503434579 REEL: 036313 FRAME: 0692

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

Name:	Teng-Chun Tsai	Nationality:	TW
Name:	Chun-Yuan Wu	Nationality:	TW
Name:	Chih-Chien Liu	Nationality:	TW
Name:	Chin-Cheng Chien	Nationality:	TW
Name:	Chin-Fu Lin	Nationality:	TW
Hereby sells, assigns and transfers to			
ASSIGNEE(S)):		
Name:	UNITED MICROELECTRONICS CORP.		
Address:	: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan,		

Assignment, Page 1 of \rightarrow

F#NPO-P0002E-US1 DSC0-100U005068

ASSIGNOR(S) (Inventors):

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"SEMICONDUCTOR DEVICE AND METHOD OF MAKING THE SAME"

Whi	ch is fou	nd in :	
(a) _	+	U.S. patent application executed or	n even date
(b) _		U.S. patent application executed or	n
(c)_		U.S. application serial no	
(d)		patent no.	issued
(e)		International application no.	

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this Signing). (新發明人務必要罪上列目明 *)

(Type name of inventor)	Signature of INVENTOR
Teng-Chun Tsai	Teng-Chun Tsai
Chun-Yuan Wu	Chan-Yuan Wu
Chih-Chien Liu	Chih-Chian Lin
Chin-Cheng Chien	Chin-chang chien
Chin-Fu Lin	Chin-Fu Lin

Assignment, Page 3 of \rightarrow

NPO#NAU-P1340-USA:0 CUST#UMCD-2011-0025 F#NPO-P0002E-US1 DSC0-100U005068

PATENT REEL: 036313 FRAME: 0695